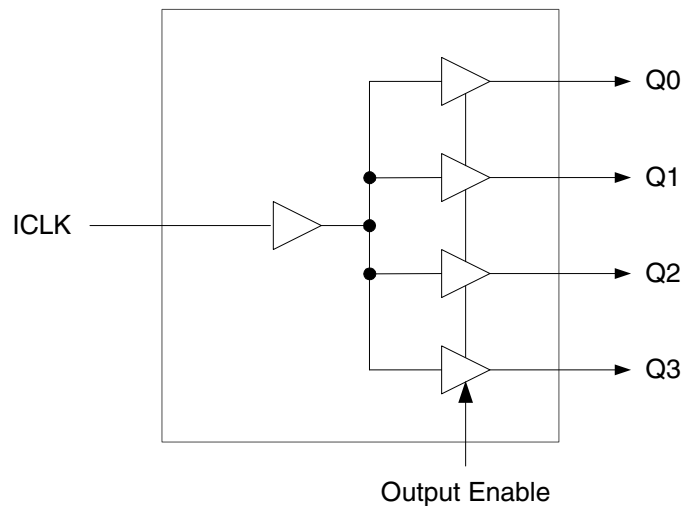# LOW SKEW 1 TO 4 CLOCK BUFFER

ICS621

Description

The ICS621 is a low skew, single input to four output, clock buffer. The device operates from a single 1.2 to 1.8 volt supply and has a 3.3 volt tolerant input, making it ideal for level translation.

IDT makes many non-PLL and PLL based low skew output devices as well as Zero Delay Buffers to synchronize clocks. Contact us for all of your clocking needs.
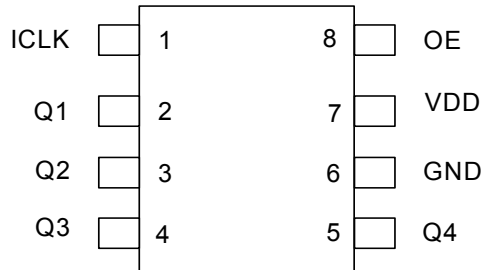
Features

- Low skew outputs (150 ps)
- Packaged in 8-pin SOIC or 8-pin DFN (2x2mm)
- Available in RoHS 5 or RoHS 6 (lead-free) package
- Low power CMOS technology
- Operating Voltages of 1.2 V to 1.8 V
- Output Enable pin tri-states outputs
- 3.3 V tolerant input clock
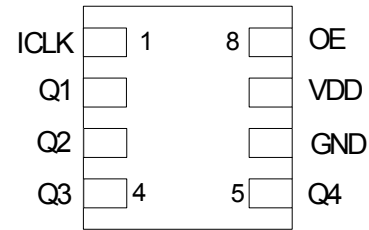- Industrial or commercial temperature ranges

Block Diagram

Pin Assignment (8-pin SOIC)

```
ICLK  ☐  1        8  ☐  OE
 Q1   ☐  2        7  ☐  VDD
 Q2   ☐  3        6  ☐  GND
 Q3   ☐  4        5  ☐  Q4
```

Pin Assignment (8-pin DFN)

```
ICLK ☐ 1      8 ☐ OE
 Q1  ☐        ☐ VDD
 Q2  ☐        ☐ GND
 Q3  ☐ 4    5 ☐ Q4
```

Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	ICLK	Input	Clock Input. 3.3 V tolerant input.
2	Q1	Output	Clock Output 1.
3	Q2	Output	Clock Output 2.
4	Q3	Output	Clock Output 3.
5	Q4	Output	Clock Output 4.
6	GND	Power	Connect to ground.
7	VDD	Power	Connect to +1.2 V or +1.8 V.
8	OE	Input	Output Enable. Tri-states outputs when low. Connect to VDD for normal operation.

External Components

A minimum number of external components are required for proper operation. A decoupling capacitor of 0.01 μF should be connected between VDD on pin 7 and GND on pin 6, as close to the device as possible. A 33 Ω series terminating resistor may be used on each clock output if the trace is longer than 1 inch.

To achieve the low output skew that the ICS621 is capable of, careful attention must be paid to board layout. Essentially, all four outputs must have identical terminations, identical loads and identical trace geometries. If they do not, the output skew will be degraded. For example, using a 30Ω series termination on one output (with 33Ω on the others) will cause at least 15 ps of skew.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS621. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	5 V
Output Enable and All Outputs	-0.5 V to VDD+0.5 V
ICLK	-0.5 V to 3.6 V (VDD > 0V)
Ambient Operating Temperature (industrial)	-40 to +85 °C
Ambient Operating Temperature (commercial)	0 to +70 °C
Storage Temperature	-65 to +150°C
Junction Temperature	125°C
Soldering Temperature	260°C

Recommended Operation Conditions

Parameter	Min.	Typ.	Max.	Units
Ambient Operating Temperature (industrial)	-40		+85	°C
Ambient Operating Temperature (commercial)	0		+70	°C
Power Supply Voltage (measured in respect to GND)	1.14		1.89	V

DC Electrical Characteristics

VDD=1.2 V ±5%, Ambient temperature -40 to +85°C or 0 to +70°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		1.14		1.26	V
Input High Voltage	V_{IH}	Note 1, ICLK, OE	0.65VDD		VDD+0.3	V
Input Low Voltage	V_{IL}	Note 1, ICLK, OE			0.35VDD	V
Output High Voltage	V_{OH}	I_{OH} = -2 mA	0.75VDD			V
Output Low Voltage	V_{OL}	I_{OL} = 2 mA			0.25VDD	V
Operating Supply Current	IDD	No load, 133 MHz		TBD		mA
Nominal Output Impedance	Z_O			20		Ω
Input Capacitance	C_{IN}	ICLK, OE pin		5		pF
Short Circuit Current	I_{OS}			±20		mA

Notes: 1. Nominal switching threshold is VDD/2

VDD=1.5 V ±5%, Ambient temperature -40 to +85°C or 0 to +70°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		1.425		1.575	V
Input High Voltage	V_{IH}	Note 1, ICLK, OE	0.65VDD		VDD+0.3	V
Input Low Voltage	V_{IL}	Note 1, ICLK, OE			0.35VDD	V
Output High Voltage	V_{OH}	I_{OH} = -6 mA	0.75VDD			V
Output Low Voltage	V_{OL}	I_{OL} = 6 mA			0.25VDD	V
Operating Supply Current	IDD	No load, 133 MHz		25		mA
Nominal Output Impedance	Z_O			20		Ω
Input Capacitance	C_{IN}	ICLK, OE pin		5		pF
Short Circuit Current	I_{OS}			±28		mA

Notes: 1. Nominal switching threshold is VDD/2

VDD=1.8 V ±5%, Ambient temperature -40 to +85°C or 0 to +70°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		1.71		1.89	V
Input High Voltage, ICLK	V_{IH}	Note 1, ICLK, OE	0.65VDD		VDD+0.3	V
Input Low Voltage, ICLK	V_{IL}	Note 1, ICLK, OE			0.35VDD	V
Output High Voltage	V_{OH}	I_{OH} = -8 mA	1.35			V
Output Low Voltage	V_{OL}	I_{OL} = 8 mA			0.45	V
Operating Supply Current	IDD	No load, 133 MHz		50		mA
Nominal Output Impedance	Z_O			20		Ω
Input Capacitance	C_{IN}	ICLK, OE pin		5		pF
Short Circuit Current	I_{OS}			±50		mA

Notes: 1. Nominal switching threshold is VDD/2

AC Electrical Characteristics

VDD = 1.2 V ±5%, Ambient Temperature -40 to +85°C or 0 to +70°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		100	MHz
Output Rise Time	t_{OR}	20% to 80%, Note 3		1.0	1.5	ns
Output Fall Time	t_{OF}	80% to 20%, Note 3		1.0	1.5	ns
Propagation Delay	Note 1		2.2	3	5	ns
Output to Output Skew	Note 2	Rising edges at VDD/2		0	±150	ps

VDD = 1.5 V ±5%, Ambient Temperature -40 to +85°C or 0 to +70°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		166	MHz
Output Rise Time	t_{OR}	20% to 80%, Note 3		1.0	1.5	ns
Output Fall Time	t_{OF}	80% to 20%, Note 3		1.0	1.5	ns
Propagation Delay	Note 1		2.2	3	5	ns
Output to Output Skew	Note 2	Rising edges at VDD/2		0	±150	ps

VDD = 1.8 V ±5%, Ambient Temperature -40 to +85°C or 0 to +70°C, unless stated otherwise

| Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		200	MHz
Output Rise Time	t_{OR}	20% to 80%, Note 3		1.0	1.5	ns
Output Fall Time	t_{OF}	80% to 20%, Note 3		1.0	1.5	ns
Propagation Delay	Note 1		2.2	3	5	ns
Output to Output Skew	Note 2	Rising edges at VDD/2		0	±150	ps

Notes: 1. With rail to rail input clock
2. Between any 2 outputs with equal loading.
3. Measured with a 15 pF load.

Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Thermal Resistance Junction to Ambient	θ_{JA}	Still air		150		°C/W
	θ_{JA}	1 m/s air flow		140		°C/W
	θ_{JA}	3 m/s air flow		120		°C/W
Thermal Resistance Junction to Case	θ_{JC}			40		°C/W
Case Temperature					120	°C
Thermal Resistance Junction to Top of Case	Ψ_{JT}	Still air		20		°C/W

## Package Outline and Package Dimensions (8-pin DFN 2x2mm, 0.5mm pitch)

Package dimensions are kept current with JEDEC Publication No. 95,
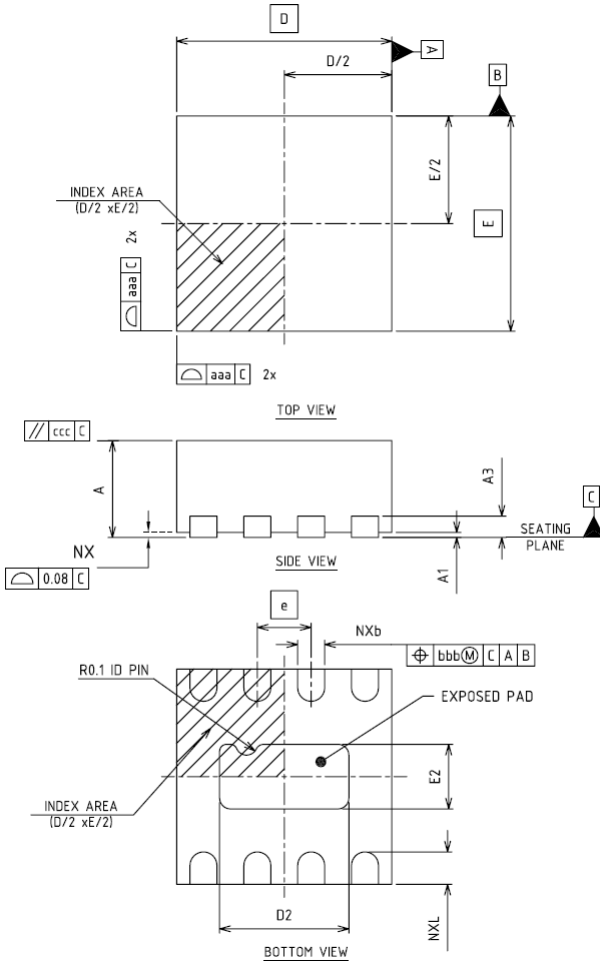
| Symbol	Millimeters	
	Min	Max
A	0.80	1.00
A1	0	0.05
A3	0.20 Reference	
b	0.20	0.30
N	8	
N_D	4	
N_E	0	
D	2.00 BASIC	
E	2.00 BASIC	
e	0.50 BASIC	
D2	1.05	1.25
E2	0.45	0.65
L	0.20	0.40
aaa	0.15	
bbb	0.10	
ccc	0.10	

Package Outline and Package Dimensions (8-pin SOIC, 150 Mil. Narrow Body)

Package dimensions are kept current with JEDEC Publication No. 95
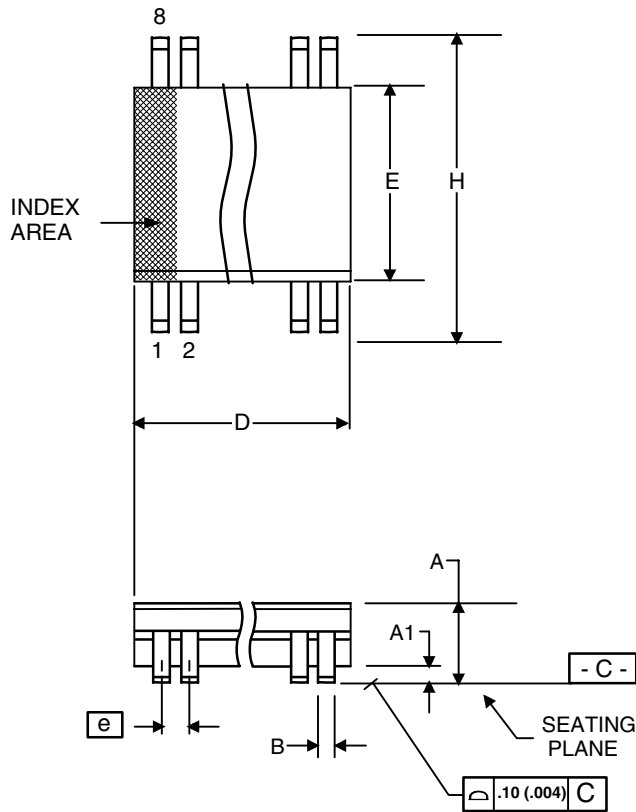
Symbol	Millimeters		Inches*	
	Min	Max	Min	Max
A	1.35	1.75	.0532	.0688
A1	0.10	0.25	.0040	.0098
B	0.33	0.51	.013	.020
C	0.19	0.25	.0075	.0098
D	4.80	5.00	.1890	.1968
E	3.80	4.00	.1497	.1574
e	1.27 BASIC		0.050 BASIC	
H	5.80	6.20	.2284	.2440
h	0.25	0.50	.010	.020
L	0.40	1.27	.016	.050
α	0°	8°	0°	8°

*For reference only. Controlling dimensions in mm.
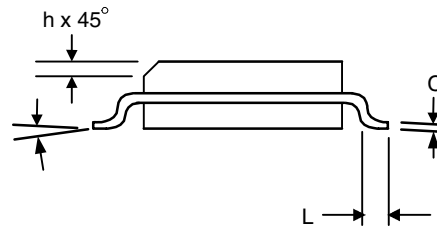
Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
ICS621MI	ICS621MI	Tubes	8-pin SOIC	-40 to +85°C
ICS621MIT	ICS621MI	Tape and Reel	8-pin SOIC	-40 to +85°C
ICS621MILF	621MILF	Tubes	8-pin SOIC	-40 to +85°C
ICS621MILFT	621MILF	Tape and Reel	8-pin SOIC	-40 to +85°C
ICS621M	ICS621M	Tubes	8-pin SOIC	0 to +70°C
ICS621MT	ICS621M	Tape and Reel	8-pin SOIC	0 to +70°C
ICS621MLF	621MLF	Tubes	8-pin SOIC	0 to +70°C
ICS621MLFT	621MLF	Tape and Reel	8-pin SOIC	0 to +70°C
ICS621NLFT	621NLF	Tape and Reel	8-pin DFN	0 to +70°C
ICS621NILFT	621NILF	Tape and Reel	8-pin DFN	-40 to +85°C

Parts that are ordered with a "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

While the information presented herein has been checked for both accuracy and reliability, Integrated Device Technology (IDT) result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by IDT. IDT reserves the right to change any circuitry or specifications without notice. IDT does not authorize or warrant any IDT product for use in life support devices or critical medical instruments.

Revision History

Rev.	Originator	Date	Description of Change
A	S. Sharma	06/08/06	New device/datasheet; Preliminary release.
B	S. Sharma	03/09/07	Removed Tape and Reel part number from DFN package ordering info.

Innovate with IDT and accelerate your future networks. Contact:

www.IDT.com

For Sales
800-345-7015
408-284-8200
Fax: 408-284-2775

For Tech Support
408-284-4522
clockhelp@idt.com

Corporate Headquarters
Integrated Device Technology, Inc.
www.idt.com

www.IDT.com